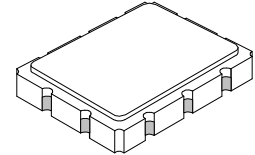


- **Designed for CATV Applications (Pilot Tone)**
- **Tightly-controlled Insertion Loss**
- **9.1 x 7.1 mm Surface-mount Case**
- **Unbalanced Input and Output**
- **Complies with Directive 2002/95/EC (RoHS)**
- **Absolute Maximum Ratings**
- **Tape and Reel Standard per ANSI/EIA-481**
- **Moisture Sensitivity Level: 1**

SF1080A

499.25 MHz
SAW Filter



SM9171-10

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage between any 2 Terminals	30	VDC
Storage Temperature Range	-54 to +85	°C
Suitable for lead-free soldering - Max Soldering Profile	260°C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Nominal Center Frequency	f_c		499.250			MHz
Passband	Insertion Loss at f_c	0.5 dB Passband	6.0	7.5	9.0	dB
		3 dB Passband	± 100			kHz
		Amplitude Ripple over $f_c \pm 100$ kHz	± 800	± 970		
Rejection	$f_c - 200$ to $f_c - 3.0$ and $f_c + 3.0$ to $f_c + 200$ MHz	Ultimate	35		0.5	dB _{P-P}
			40			dB
Operating Temperature Range	T_A		-25		+75	°C

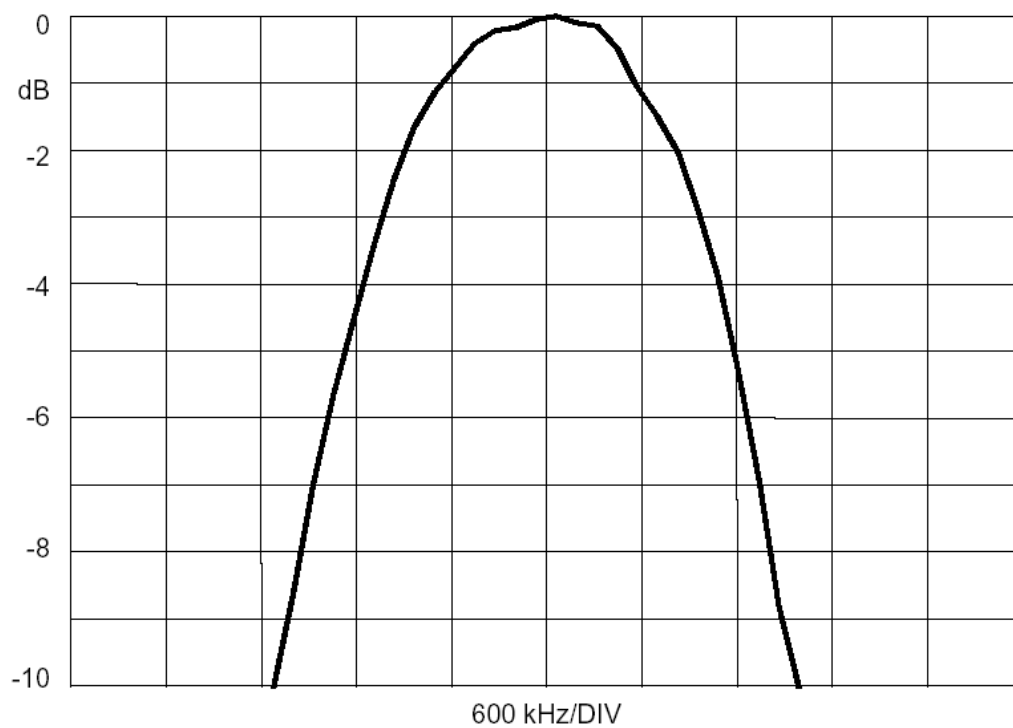
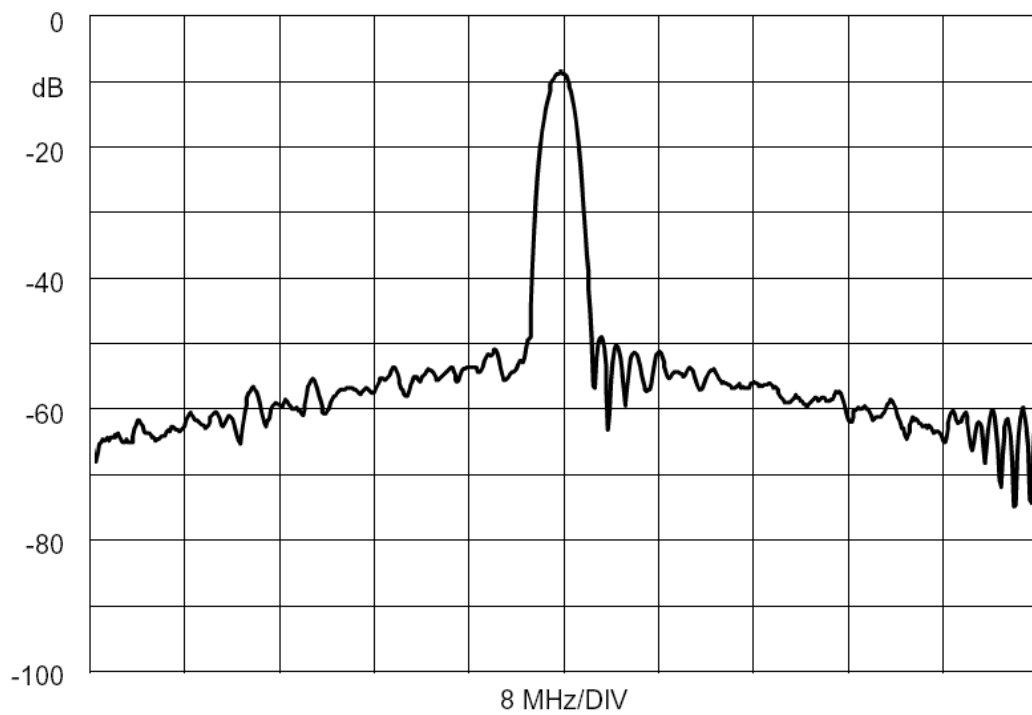
Impedance Matching to 50 Ω unbalanced	External L-C
Lid Symbolization (YY=year, WW=week, S=shift, ##=sequence code)	RFM, SF1080A, YYWWS##
Case Style: SM9171-10 9.1 x 7.1 mm Nominal Footprint	Reel Count: 7" = 500, 13" = 1000

Electrical Connections

Connection	Terminals
Port 1 Hot	10
Port 1 Gnd Return	1
Port 2 Hot	5
Port 2 Gnd Return	6
Case Ground	All others

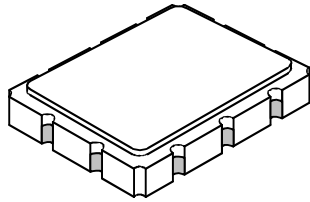
 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.



SM9171-10 Case

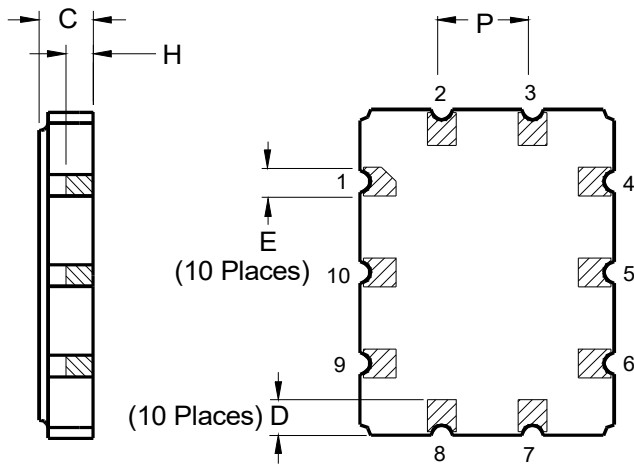
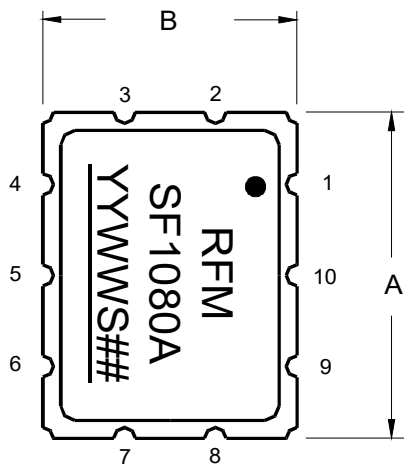
10-Terminal Ceramic Surface-Mount Case 9.1 x 7.1 mm Nominal Footprint



Case Dimensions						
Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	8.86	9.09	9.40	0.349	0.358	0.370
B	6.88	7.11	7.40	0.271	0.280	0.291
C		1.91	2.00		0.075	0.079
D		0.99			0.039	
E		0.79			0.031	
H		1.0			0.039	
P		2.54			0.100	

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic

Electrical Connections		
Connection		Terminals
Port 1	Input or Return	6
	Return or Input	5
Port 2	Output or Return	1
	Return or Output	10
Ground		All others
Single Ended Operation		Return is ground
Differential Operation		Return is hot



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

